



## **Features**

- High speed up to 6000/6400/6800MT/s
- Heat sink design enhances memory dissipation
- intel XMP 3.0 and AMD EXPO Support
- Compatibility with intel and AMD platforms
- Carefully selected high-quality chips from originalmanufacturers
- Meeting JEDEC standards
- Built-in Power Management IC
- Support On-die ECC error correction functionality
- High-quality PCB provides improved signal transfer and system stability

## Ordering Information

| Speed     | Capacity     | CL | EAN Code      | Part Number       |
|-----------|--------------|----|---------------|-------------------|
| 6000 MT/s | 32GB(16GBx2) | 30 | 4718009613119 | AGI6AWB16UD858-DR |
| 6400 MT/s | 32GB(16GBx2) | 32 | 4718009613126 | AGI6GWB16UD858-DR |
| 6400 MT/s | 32GB(16GBx2) | 36 | 4718009614215 | AGI6IWB16UD858-DR |
| 6800 MT/s | 32GB(16GBx2) | 34 | 4718009613133 | AGI6JWB16UD858-DR |

## **Specifications**

• Capacity: 32GB (16GB x2)

• Module: 288-pin UDIMM

• Operating voltage: 1.35/1.4V

• Heat Sink Color: Black

• Operating temperature: 0°C to 85°C

• Dimensions (L x W): 137.35 x 33.4 mm

• Weight: 65g (2pcs)

Warranty: Lifetime

## **Dual Retail**

